

SMAG Plastic-Encapsulate Diodes

Schottky Rectifier

Features

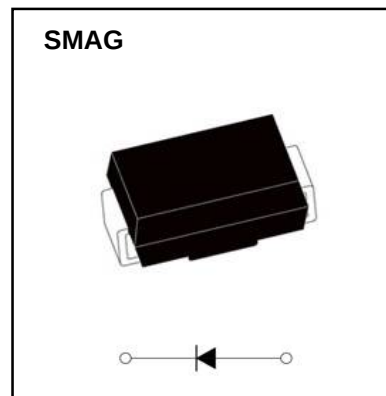
- I_o 2A
- V_{RRM} 20V-200V
- High surge current capability
- Polarity: Color band denotes cathode

Applications

- Rectifier

Marking

- SS2X
- X : From 2 To 20



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	SS2								
				2	3	4	5	6	8	10	15	20
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	V _{RMS}	V		14	21	28	35	42	56	70	105	140
Average Forward Current	I _{F(AV)}	A	60HZ Half-sine wave, Resistance load, TL(Fig.1)	2.0								
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave ,1 cycle , Ta =25℃	50								
Junction Temperature	T _J	℃		-55~+125			-55~+150					
Storage Temperature	T _{STG}	℃		-55 ~ +150								

Electrical Characteristics ($T_a = 25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		SS2								
					2	3	4	5	6	8	10	15	20
Peak Forward Voltage	V _F	V	I _F =2.0A		0.55			0.7		0.85		0.95	
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	T _a =25℃	0.5				0.1				
	T _a =100℃			10				5.0					
Thermal Resistance(Typical)	R _{θJ-A}	℃/ W	Between junction and ambient		75 ¹⁾								
	Between junction and terminal		17 ¹⁾										

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

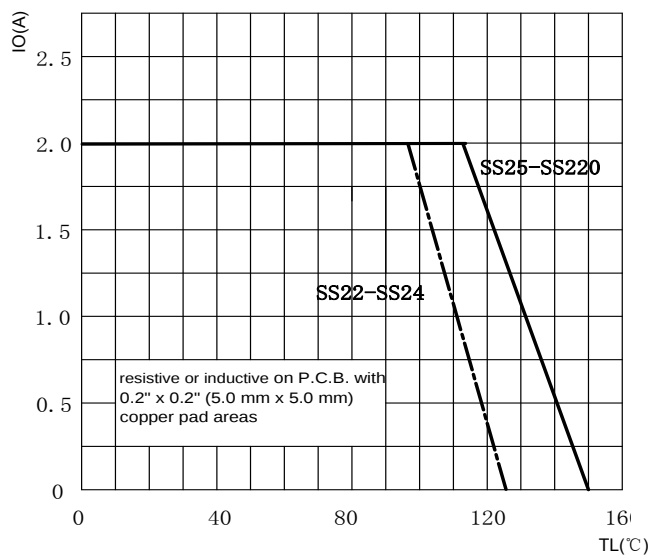


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

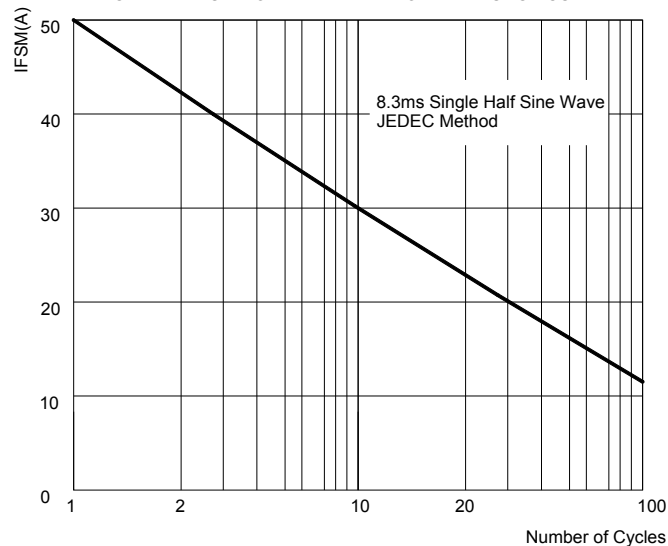


FIG.3: TYPICAL FORWARD CHARACTERISTICS

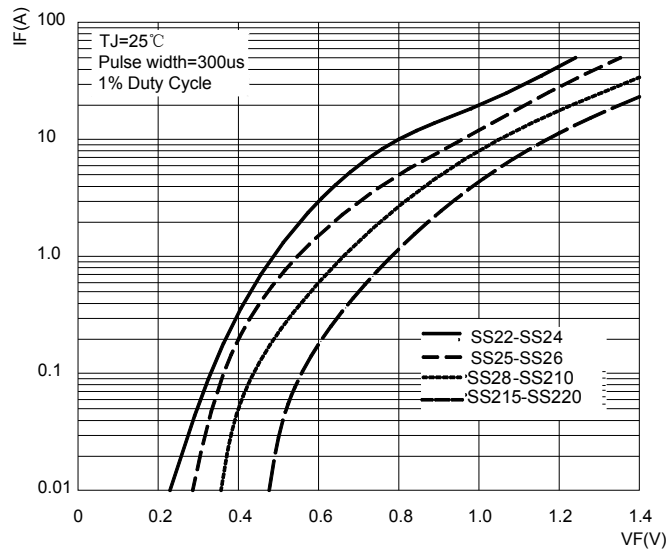
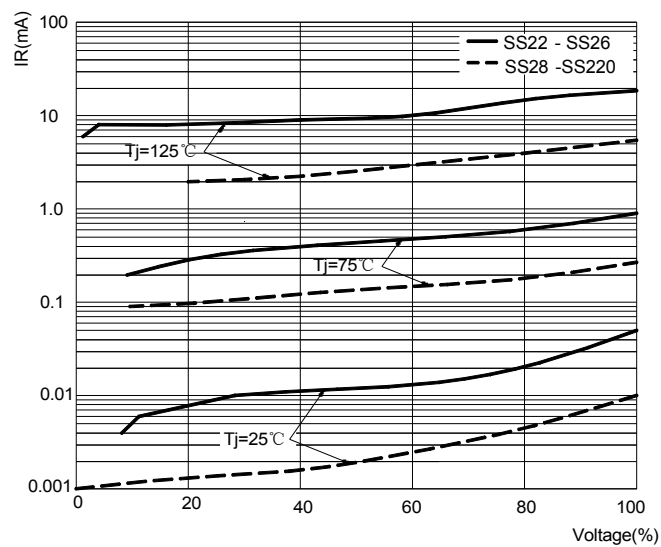
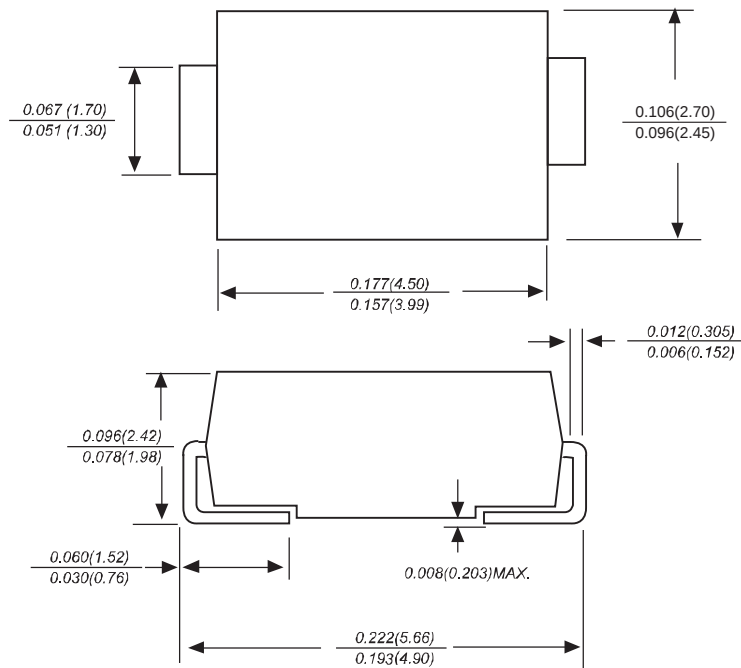


FIG.4: TYPICAL REVERSE CHARACTERISTICS

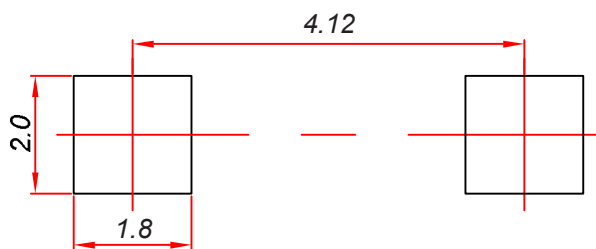


SMAG Package Outline Dimensions



Dimensions in inches and (millimeters)

SMAG Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

JSHD reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. JSHD does not assume any liability arising out of the application or use of any product described herein.

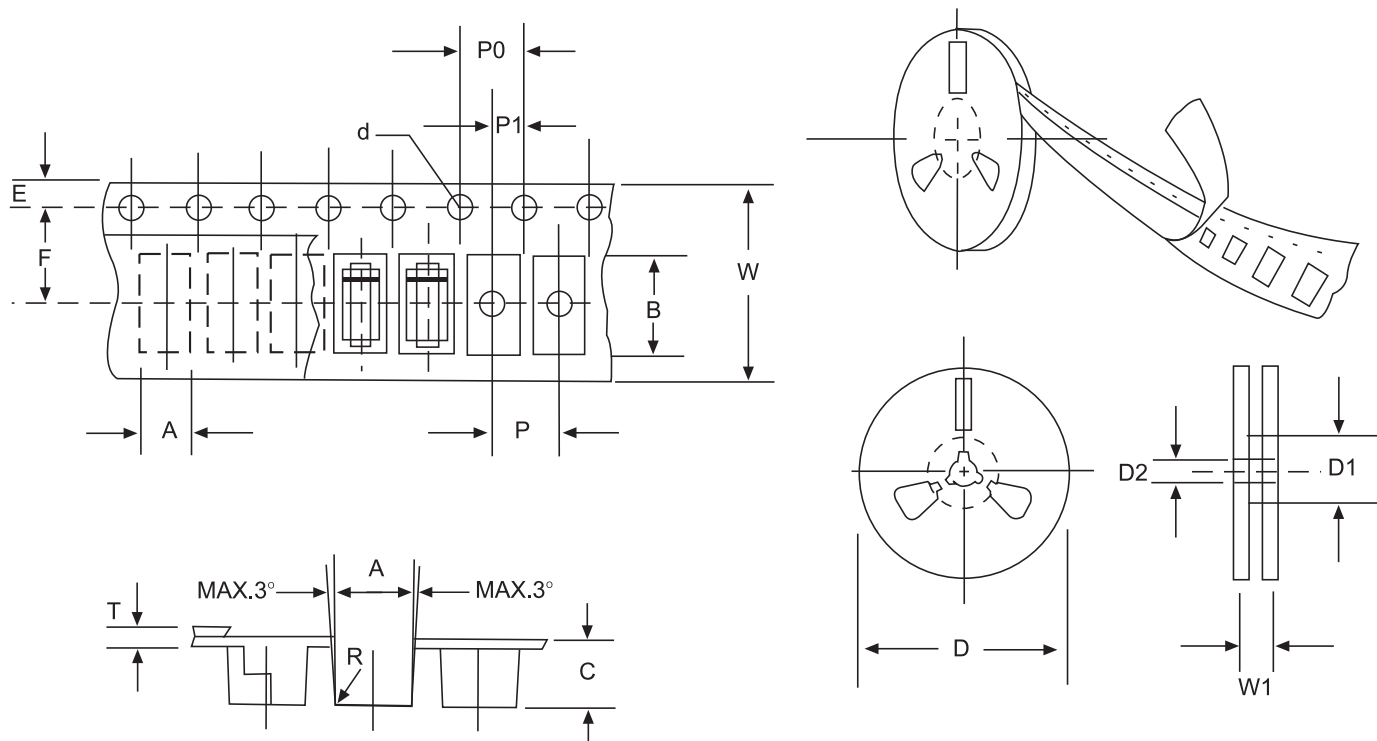


Fig:CONFIGURATION OF FLAT MELF TAPING

ITEM	SYMBOL	SMAG mm(inch)
Carrier width	A	2.79±0.1(0.110±0.004)
Carrier length	B	5.33±0.1(0.210±0.004)
Carrier depth	C	2.36±0.1(0.093±0.004)
Sprocket hole	d	1.55±0.05 (0.061±0.002)
Reel outside diameter	D	279±2.0 (11± 0.079)
Reel inner diameter	D1	75 ±1.0 (2.95 ±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	5.5±0.05(0.217±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.28±0.02(0.011 ±0.0008)
Tape width	W	12.0±0.2(0.472±0.008)
Reel width	W1	16.8±2.0(0.661±0.079)

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.